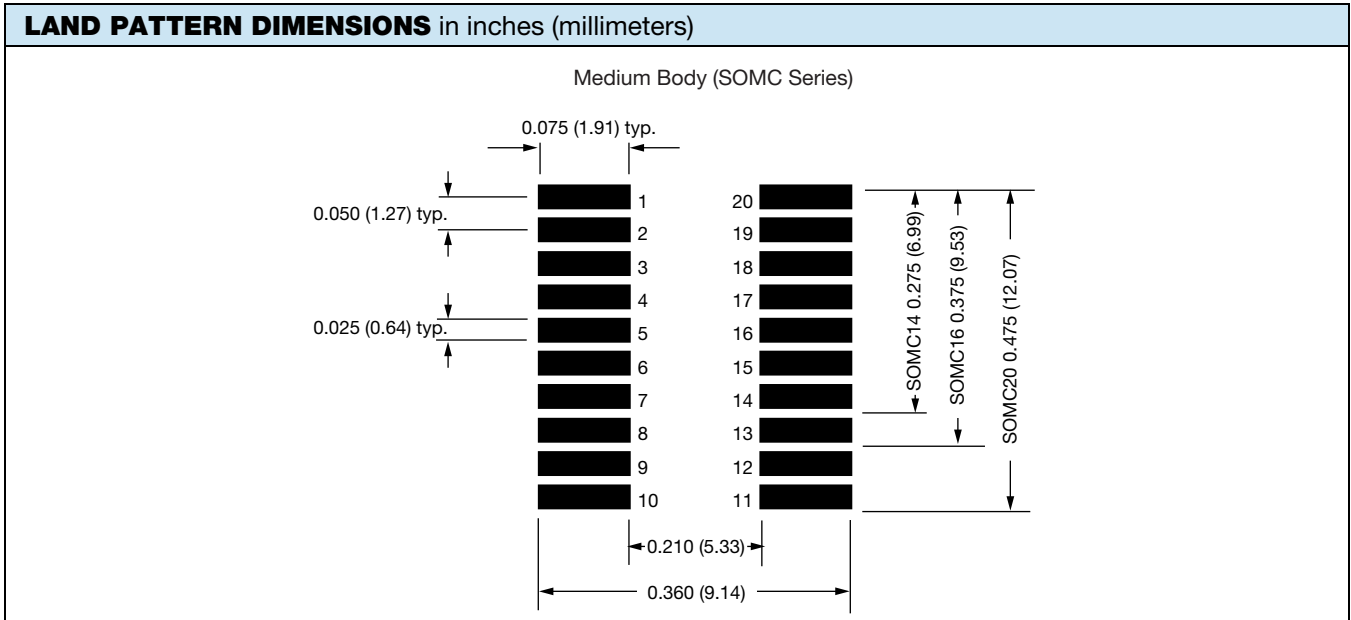
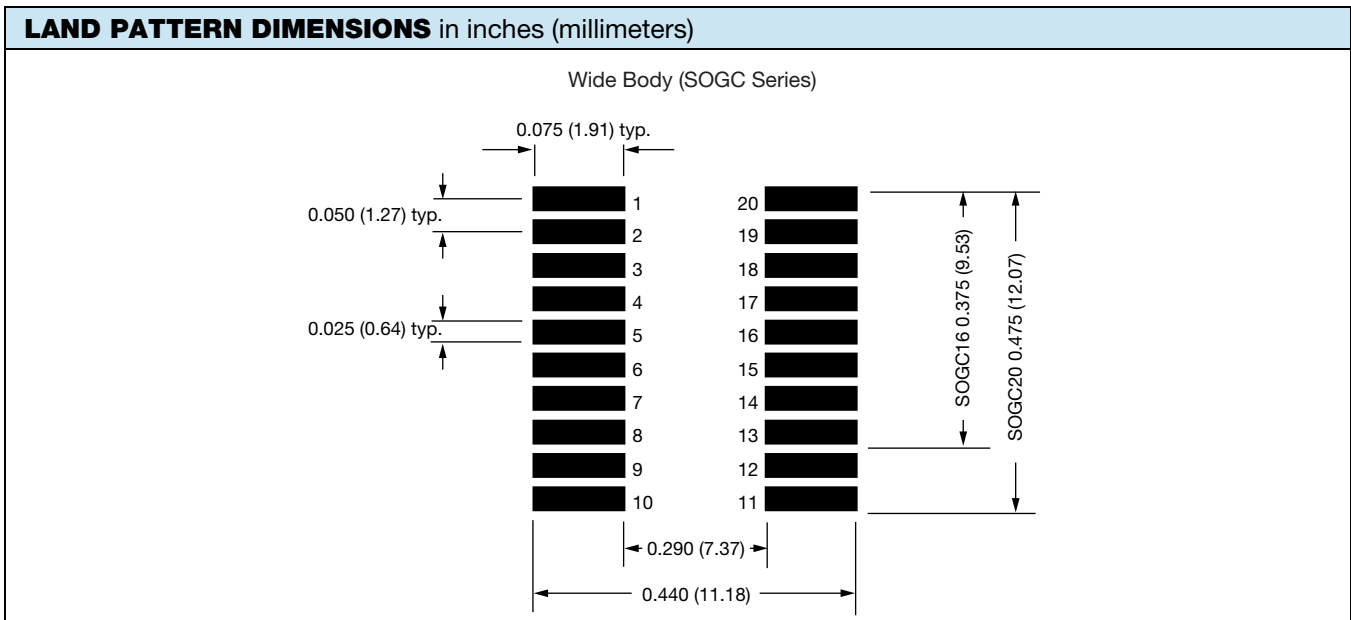


Recommended Solder Pads for Surface Mount Small Outline Dual-In-Line Resistor Networks



Note

- Land pattern dimensions are based on design rules established by the Institute for Interconnecting and Packaging Electronic Circuits in IPC-SM-782



Note

- Land pattern dimensions are based on design rules established by the Institute for Interconnecting and Packaging Electronic Circuits in IPC-SM-782